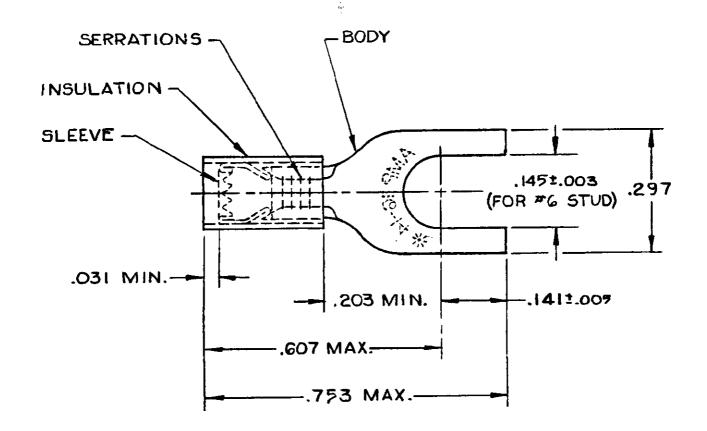
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- / WIRE INSULATION DIA. = .115 -.170
- 2 TONGUE MATERIAL THK. = .031±.002
- TIN PLATE (MIL-T-10727) .000100 MIN THK.